Monolithic temperature and

overload protected logic level power MOSFET in **TOPFET2** technology assembled in a 3 pin plastic

General purpose switch for driving

TrenchMOS output stage

Overtemperature protection Protection latched reset by input

5 V logic compatible input level Control of output stage and supply of overload protection

circuits derived from input

Low operating input current

ESD protection on all pins

Overvoltage clamping for turn

permits direct drive by micro-controller

off of inductive loads

DESCRIPTION

APPLICATIONS

package.

lamps

motors solenoids

heaters

FEATURES

Current limiting Overload protection

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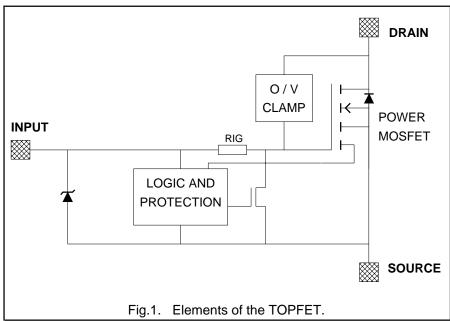
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Logic level TOPFET

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
$V_{DS} \\ I_D \\ P_D \\ T_j \\ R_{DS(ON)}$	Continuous drain source voltage Continuous drain current Total power dissipation Continuous junction temperature Drain-source on-state resistance	50 20 90 150 28	V A W °C mΩ
I _{ISL}	Input supply current $V_{IS} = 5 V$	650	μA

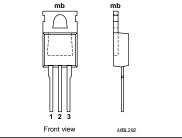
FUNCTIONAL BLOCK DIAGRAM



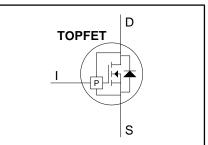
PINNING - SOT78B

PIN	DESCRIPTION
1	input
2	drain
3	source
tab	drain

PIN CONFIGURATION



SYMBOL



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LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	Continuous drain source voltage ¹		-	50	V
I _D	Continuous drain current	$V_{IS} = 5 V; T_{mb} = 25^{\circ}C$	-	self -	А
				limited	
I _D	Continuous drain current	V _{IS} = 5 V; T _{mb} ≤121°C	-	20	А
I,	Continuous input current		-5	5	mA
I _{IRM}	Repetitive peak input current	$δ \le 0.1$, tp = 300 μs	-50	50	mA
P _D	Total power dissipation	$T_{mb} \le 25^{\circ}C$	-	90	W
T _{stg}	Storage temperature		-55	175	°C
Tj	Continuous junction temperature ²	normal operation	-	150	°C
T_{sold}	Lead temperature	during soldering	-	260	°C

ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _c	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 k Ω	-	2	kV

OVERVOLTAGE CLAMPING LIMITING VALUES

At a drain source voltage above 50 V the power MOSFET is actively turned on to clamp overvoltage transients.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
E _{DSM} E _{DRM}	Inductive load turn-off Non-repetitive clamping energy Repetitive clamping energy	$ \begin{split} I_{DM} &= 20 \text{ A}; V_{DD} \leq 20 \text{ V} \\ T_{mb} &\leq 25 ^\circ\text{C} \\ T_{mb} &\leq 95 ^\circ\text{C}; f = 250 \text{Hz} \end{split} $	-	350 45	mJ mJ

OVERLOAD PROTECTION LIMITING VALUE

With an adequate protection supply provided via the input pin, TOPFET can protect itself from two types of overload - overtemperature and short circuit load.

SYMBOL	PARAMETER	REQUIRED CONDITION	MIN.	MAX.	UNIT	
V _{DS}	Drain source voltage ³	$4~V \leq V_{IS} \leq 5.5~V$	0	35	V	

THERMAL CHARACTERISTIC

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Thermal resistance					
R _{th j-mb}	Junction to mounting base	-	-	1.25	1.39	K/W

¹ Prior to the onset of overvoltage clamping. For voltages above this value, safe operation is limited by the overvoltage clamping energy.

² A higher T_j is allowed as an overload condition but at the threshold $T_{j(TO)}$ the over temperature trip operates to protect the switch.

³ All control logic and protection functions are disabled during conduction of the source drain diode.

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OUTPUT CHARACTERISTICS

Limits are for -40°C \leq T_{mb} \leq 150°C; typicals are for T_{mb} = 25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Off-state	$V_{IS} = 0 V$				
V _{(CL)DSS}	Drain-source clamping voltage	I _D = 10 mA	50	-	-	V
		I_{DM} = 4 A; $t_{p} \le 300 \ \mu\text{s}; \ \delta \le 0.01$	50	60	70	V
I _{DSS}	Drain source leakage current	$V_{DS} = 40 V$	-	-	100	μA
		$T_{mb} = 25^{\circ}C$	-	0.1	10	μA
	On-state	$V_{\text{IS}} \geq 4.4~\text{V};~t_{\text{p}} \leq 300~\mu\text{s};~\delta \leq 0.01$				
R _{DS(ON)}	Drain-source resistance	I _{DM} = 10 A	-	-	52	mΩ
		$T_{mb} = 25^{\circ}C$	-	22	28	mΩ

OVERLOAD CHARACTERISTICS

 V_{IS} = 5 V; T_{mb} = 25°C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Short circuit load					
I _D	Drain current limiting	V _{DS} = 13 V	28.5	43	57	А
		$4.4 V \le V_{IS} \le 5.5 V;$ -40°C ≤ T _{mb} ≤ 150°C	21	-	65	A
	Overload protection					
$P_{D(TO)}$	Overload power threshold	device trips if $P_D > P_{D(TO)}$	75	185	250	W
T _{DSC}	Characteristic time	which determines trip time ¹	200	380	600	μs
	Overtemperature protection					
$T_{j(TO)}$	Threshold junction temperature ²		150	170	-	°C

¹ Trip time $t_{d \, sc}$ varies with overload dissipation P_D according to the formula $t_{d \, sc} \approx T_{DSC} / \ln[P_D / P_{D(TO)}]$.

 $[\]boldsymbol{2}$ This is independent of the dV/dt of input voltage $V_{\text{IS}}.$

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INPUT CHARACTERISTICS

The supply for the logic and overload protection is taken from the input. Limits are for -40°C $\leq T_{mb} \leq 150$ °C; typicals are for $T_{mb} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
V _{IS(TO)}	Input threshold voltage	$V_{DS} = 5 V; I_{D} = 1 mA$	T _{mb} = 25°C	0.6 1.1	- 1.6	2.4 2.1	V V
I _{IS}	Input supply current	normal operation;	V _{IS} = 5 V V _{IS} = 4 V	100 80	220 195	400 330	μΑ μΑ
I _{ISL}	Input supply current	protection latched;	V _{IS} = 5 V V _{IS} = 3 V	200 130	400 250	650 430	μΑ μΑ
V _{ISR}	Protection reset voltage ¹	reset time $t_r \ge 100 \ \mu s$		1.5	2	2.9	V
t _{ır}	Latch reset time	$V_{IS1} = 5 V, V_{IS2} < 1 V$		10	40	100	μs
V _{(CL)IS}	Input clamping voltage	l _i = 1.5 mA		5.5	-	8.5	V
R _{IG}	Input series resistance ² to gate of power MOSFET		$T_{mb} = 25^{\circ}C$	-	33	-	kΩ

SWITCHING CHARACTERISTICS

 T_{mb} = 25°C; V_{DD} = 13 V; resistive load R_L = 4 Ω . Refer to waveform figure and test circuit.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t _{d on}	Turn-on delay time	$V_{IS} = 5 V$	-	25	50	μs
t,	Rise time		-	50	100	μs
t _{d off}	Turn-off delay time	$V_{IS} = 0 V$	-	60	120	μs
t _r	Fall time		-	50	100	μs

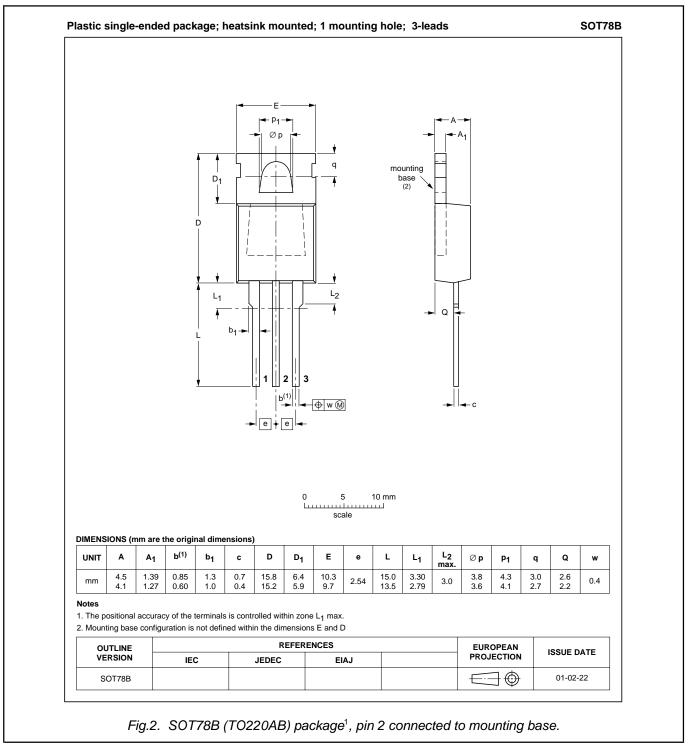
¹ The input voltage below which the overload protection circuits will be reset.

² Not directly measureable from device terminals.

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MECHANICAL DATA



¹ Refer to mounting instructions for SOT78 (TO220) envelopes. Epoxy meets UL94 V0 at 1/8". Net mass: 2 g

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DEFINITIONS

DATA SHEET STA	TUS	
DATA SHEET STATUS ¹	PRODUCT STATUS ²	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice
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Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A
Limiting values	•	·

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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